



User's Guide

NHD-160128WG-BTMI-VZ# LCM

(Liquid Crystal Display Graphic Module) **RoHS Compliant**

NHD-Newhaven Display 160128-160 x 128 Dots

WG-W- Version Line G- Display Type= Graphic

B-Model/Serial Number Т-White LED B/L M-STN-(negative)Blue

Transflective, 6:00 View, Wide Temperature $(-20 \sim +70c)$ VZ#-V: Build in Negative Voltage Z:ICNT7086 #: RoHS

For product support, contact

Newhaven Display International 2511 Technology Drive, #101 Elgin, IL 60124

Tel: (847) 844-8795 Fax: (847) 844-8796

REC	ORDS OF REV		DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2007.03.20		First issue

Contents

- 1. Module Classification Information
- 2. Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7. Power Supply for LCD Module and Contrast Adjust
- 8. Outline dimension and block diagram
- 9.Interface Pin Function
- 10.Display control instruction
- 11. Timing Characteristics
- 12.Reliability
- 13.Backlight Information
- 14. Inspection specification
- 15. Material List of Components for RoHs

1. Module Classification Information

NHD 160128 W G - B T M I - VZ#

① ② ③ ④ ⑤ ⑥ ⑦ ® 9

① Brand: Newhaven Display

② Display Font: 160 * 128 Dots

3 Factory Line: W

4 Display Type : H \rightarrow Character Type, G \rightarrow Graphic Type, C \rightarrow Color, X \rightarrow Tab Type

Model / Serial number:

© Backlight Type: N→Without backlight T→White LED

 $B \rightarrow EL$, Blue green $A \rightarrow LED$, Amber $D \rightarrow EL$, Green $R \rightarrow LED$, Red $W \rightarrow EL$, White $O \rightarrow LED$, Orange $F \rightarrow CCFL$, White $G \rightarrow LED$, Green

Y→LED, Yellow Green

 \bigcirc LCD Mode : B \rightarrow TN Positive, Gray T \rightarrow FSTN Negative

N→TN Negative, Y→STN Positive, Yellow Green

G→STN Positive, Gray M→STN Negative, Blue

F→FSTN Positive

Temperature range/ D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 View direction

G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

 $B \rightarrow Transflective, N.T,6:00$ $I \rightarrow Transmissive, W. T, 6:00$

E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

9 Special Code V: Build in Negative Voltage Z:ICNT7086 #: RoHS

2. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist LCM.
- (6) Soldering:only to the I/O terminals.
- (7) Storage:please storage in anti-static electricity container and clean environment.

3. General Specification

ITEM	STANDARD VALUE	UNIT				
Number of Dots	160 ×128					
Module dimension	dimension 129.0×102.0×15.6(MAX)					
View area	101.0×82.0	mm				
Active area	95.96 x 76.76	mm				
Dot size	0.56×0.56	mm				
Dot pitch	0.60 ×0.60	mm				
LCD type	STN Negative, Blue Transmi	ssive,				
Duty	1/128					
View direction	6 o'clock					
Backlight	LED, White					

4. Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Operating Temperature	T_{OP}	-20	-	+70	°C
Storage Temperature	T_{ST}	-30	-	+80	°C
Input Voltage	V _I	V_{SS}	-	V_{DD}	V
Supply Voltage For Logic	Vcc-Vss	-0.3	-	+7	V
Supply Voltage For LCD	V _{CC} -V _{EE}	0	-	28	V

5. Electrical Characteristics

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	V_{DD} - V_{SS}	-	4.75	5.0	5.25	V
		Ta=-20°C	-	-	22.1	V
Supply Voltage For LCD	$ m V_{DD} ext{-}V_0$	Ta=25°C	-	19.2	-	V
		Ta=70°C	16.8	-	-	V
Input High Volt.	$ m V_{IH}$	-	V _{DD} -2.2	-	V_{DD}	V
Input Low Volt.	V_{IL}	-	0	-	0.8	V
Output High Volt.	V_{OH}	-	V _{DD} -0.3	ı	V_{DD}	V
Output Low Volt.	V_{OL}	-	0	-	0.3	V
Supply Current	I_{DD}	V _{DD} =5.0V	30	42	50	mA

6. Optical Characteristics

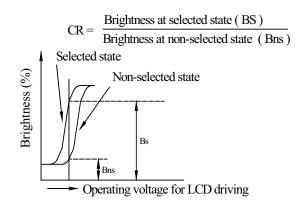
ITEM	SYMBAL	CONDITION	MIN.	TYP.	MAX.	UNIT
	(V)θ	CR≧ 2	20		40	deg
View Angle	(Н)ф	CR≧ 2	-30		30	deg
Contrast Ratio	CR	-		3		-
	T rise	-		200	300	ms
Response Time	T fall	-		200	300	ms

6.1 **Definitions**

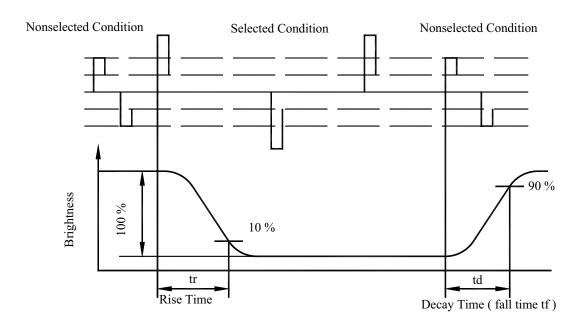
■View Angles

$\begin{array}{c} Z \qquad \text{(Visual angle direction)} \\ \theta \\ \hline \\ Y \\ \text{(Best visual angle direction)} \end{array}$

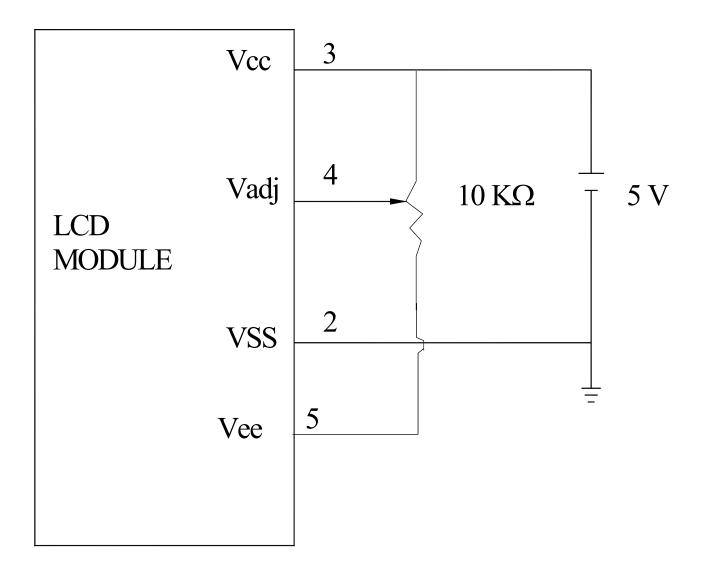
Contrast Ratio



■ Response Time

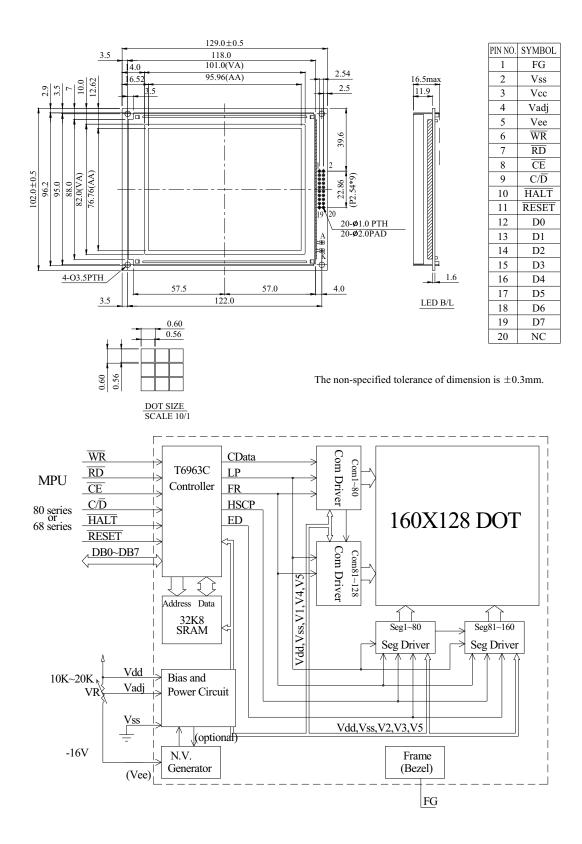


7. Power Supply for LCD Module and Contrast Adjust



VDD-V0:LCD Operating Voltage

8. Outline dimension & block diagram



9. Interface Pin Function

Pin No.	Symbol	Level	Description
1	FG		Frame ground
2	Vss	0V	Ground
3	VDD	5.0V	Power supply for logic
4	Vadj		Power supply for LCD contrast adjustment
5	Vee		-16v Output
6	/WR	L	Data write. Write data into T6963C when /WR = L
7	/RD	L	Data read. Read data from T6963C when RD = L
8	/CE	L	Chip enable the controller T6963C
9	C/D	H/L	WR=L, C/D=H: Command Write C/D=L: Data write
			RD=L, C/D=H: Status Read C/D=L: Data read
10	/HALT	L	Clock operating stop signal
11	/RESET	L	Reset signal
12	DB0	H/L	Data bus line
13	DB1	H/L	Data bus line
14	DB2	H/L	Data bus line
15	DB3	H/L	Data bus line
16	DB4	H/L	Data bus line
17	DB5	H/L	Data bus line
18	DB6	H/L	Data bus line
19	DB7	H/L	Data bus line
20	NC		NC

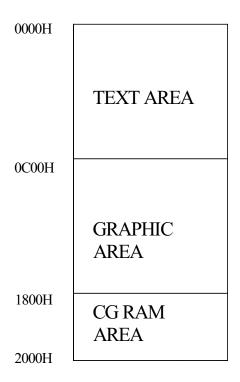
10. Display control instruction

The LCD Module has built in a T6963C LSI controller, It has an 8-bit parallel data bus and control lines for writing or reading through an MPU interface, it has a 128-word character generator ROM (refer to Table 1.), which can control an external display RAM of up to 8K bytes. Allocation of text, graphics and external character generator RAM can be made easily and the display window can be moved freely within the allocated memory range.

•RAM Interface

The external RAM is used to store display data(text, graphic and external CG data). It can be freely allocated to the memory area(8 Kbyte max).

Recommend



· Flowchart of communications with MPU

(1)Status Read

A status check must be performed before data is read or written.

Status check

The Status of T6963C can be read from the data lines.

RD	L
$\overline{ m WR}$	Н
CE	L
C/D	Н
Do to D7	Н

The T6963C status word format is as follows:

MSB LSB

STA7	STA6	STA5	STA4	STA3	STA2	STA1	STA0
D7	D6	D5	D4	D3	D2	D1	D0

STA0	Check command execution capability	0:Disable 1:Enable
STA1	Check data read/write Capability	0:Disable 1:Enable
STA2	Check Auto mode data read capability	0:Disable 1:Enable
STA3	Check Auto mode data write capability	0:Disable 1:Enable
STA4	Not used	
STA5	Check controller operation capability	0:Disable 1:Enable
STA6	Error flag. Used for Screen Peek and Screen copy commands.	0:No error 1:Error
STA7	Check the blink condition	0:Disable off 1:Normal display

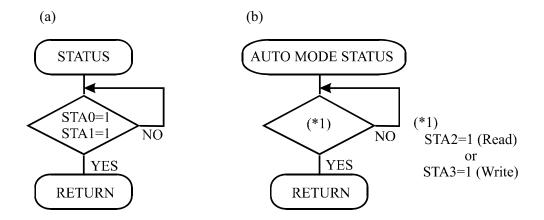
(Note 1) It is necessary to check STA0 and STA1 at the same time.

There is a possibility of erroneous operation due to a hardware interrupt.

(Note 2) For most modes STA0/STA1 are used as a status check.

(Note 3) STA2 and STA3 are valid in Auto mode; STA0 and STA1 are invalid.

Status Checking flow



(Note 4) When using the MSB=0 command, a Status Read must be performed.

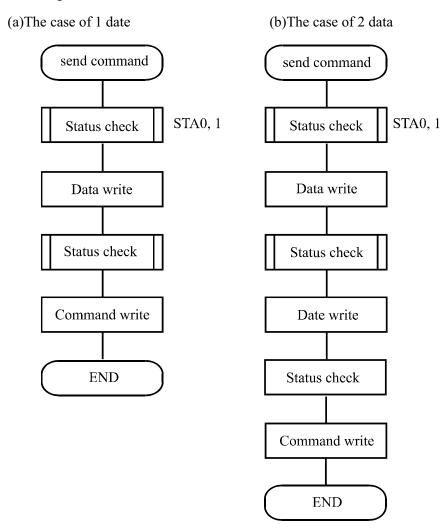
If a status check is not carried out, the T6963C cannot operate normally, even after a delay time.

The hardware interrupt occurs during the address calculation period (at the end of each line). If a MSB=0 command is sent to the T6963C during this period, the T6963C enters Wait status. If a status check is not carried out in this state before the next command is sent, there is the possibility that the command or data date will not be received.

(2)Setting date

When using the T6963C, first set the data, then set the command.

Procedure for sending a command



(Note) When sending more than two data, the last datum (or last two data)is valid.

· COMMAND DEFINITIONS

COMMAND	CODE	D1	D2	FUNCTION
REGISTERS SETTING	00100001 00100010 00100100	X address Date Low address	Y address 00H High address	Set Cursor Pointer Set Offset Register Set Address Pointer
SET CONTROL WORD	01000000 01000001 01000010 01000011	Low address Columns Low address Columns	High address 00H High address 00H	Set Text Home Address Set Text Area Set Graphic Home Address Set Graphic Area
MODE SET	1000x000 1000x001 1000x011 1000x100 10000xxx 10001xxx	- - - - -	- - - - -	OR mode EXOR mode AND mode Text Attribute mode Internal CG ROM mode External CG RAM mode
DISPLAY MODE	10010000 1001xx10 1001xx11 100101xx 100110xx 100111xx	- - - - -	- - - - -	Display off Cursor on, blink off Cursor on, blink on Text on, graphic off Text off, graphic on Text on, graphic on
CURSOR PATTERN SELECT	10100000 10100001 10100010 10100011 1010010			1-line cursor 2-line cursor 3-line cursor 4-line cursor 5-line cursor 6-line cursor 7-line cursor
DATA AUTO READ/WRITE	10110000 10110001 10110010		- - -	Set Data Auto Write Set Data Auto Read Auto Reset
DATA READ/WRITE	11000000 11000001 11000010 11000011 11000100 11000101	Data - Data - Data -	- - - - -	Data Write and Increment ADP Data Read and Increment ADP Data Write and Decrement ADP Data Read and Decrement ADP Data Write and Non-variable ADP Data Read and Non-variable ADP
SCREEN PEEK	11100000	-	-	Screen Peek
SCREEN COPY	11101000			Screen Copy

		-	-	
	11110	-	-	D'A D
	11110xxx			Bit Reset
	111111xxx	-	-	Bit Set
	1111x000	_	_	Bit 0 (LSB)
	1111x001			Bit 1
BIT SET/RESET	1111x010	-	-	Bit 2
BIT SET/KESET	1111x011	_	_	Bit 3
	1111x100			Bit 4
	1111x101	-	-	Bit 5
	1111x110	_	_	Bit 6
	1111x111			Bit 7 (MSB)
		-	-	
		-	-	

X : invalid

· Setting registers

CODE	HEX.	FUNCTION	D1	D2
00100001	21H	SET CURSOR POINTER	X ADRS	YADRS
00100010	22H	SET OFFSET REGISTER	DATA	00H
00100100	24H	SET ADDRESS POINTER	LOW ADRS	HIGH ADRS

(1)Set Cursor Pointer

The position of the cursor is specified by X ADRS and Y ADRS. The cursor position can only be moved by this command. Data read/write from the MPU never changes the cursor pointer. X ADRS and Y ADRS are specified as follows.

X ADRS 00H to 4FH (lower 7 bits are valid)

Y ADRS 00H to 1FH (lower 5 bits are valid)

Single-Scan

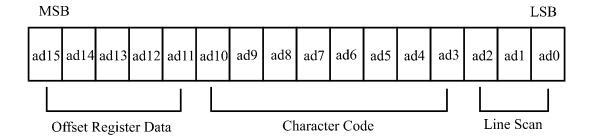
X ADRS 00 to 4FH

Y ADRS 00H to 0FH

(2)Set Offset Register

The offset register is used to determine the external character generator RAM area.

The T6963C has a 16-bit address bus as follows.

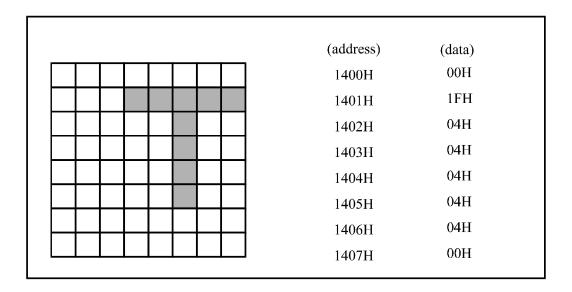


T6963C assign External character generator, when character code set 80H TO FFH in using internal character generator. Character code 00H to 80H assign External character generator, when External generator mode.

The senior five bits define the start address in external memory of the CG RAM area. The next eight bits represent the character code of the character. In internal CG ROM, character codes 00H to 7FH represent the predefined "internal" CG ROM characters, and codes 80H to FFH represent the user's own "external" characters. In external CG ROM mode, all 256 codes from 00H to FFH can be used to represent the user's own characters. The three least significant bits indicate one of the eight rows of eight dots that define the character's shape.

The relationship between display RAM address and offset register

Offset register data	CG RAM hex. address (start to end)
00000	0000 to 07 FFH
00001	0800 to 0FFFH
00010	1000 to 17FFH
11100	E000 to E7FFH
11101	E800 to EFFFH
11110	F000 to F7FFH
11111	F800 to FFFFH
(Example 1)	
Offset register	02H
Character code	80H
Character generator RAM start address	0001 0100 0000 0000
	1 4 0 0 H



(Example 2) The relationship between display RAM data and display characters

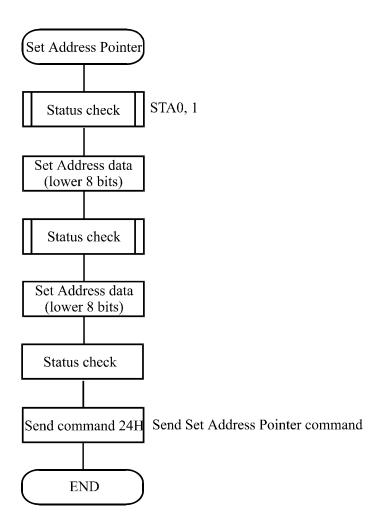
	(RAM DATA)	(Character)
AB γ DE ζ GHIJKLM	21H	A
ABY DE CHIJKEM	22Н	В
	83H	γ
	24H	D
	25H	E
	J 86H	ζ
Display character		

 γ and ζ are displayed by character generator RAM.

(3)Set Address Pointer

The Set Address Pointer command is used to indicate the start address for writing to (or reading from)external RAM.

The Flowchart for Set Address Pointer command



· Set Control Word

CODE	HEX.	FUNCTION	D1	D2
01000000	40H	Set Text Home Address	Low address	High address
01000001	41H	Set Text Area	Columns	00H
01000010	42H	Set Graphic Home Address	Low address	High address
01000011	43H	Set Graphic Area	Columns	00H

The home address and column size are defined by this command.

(1)Set Text Home Address

The starting address in the external display RAM for text display is defined by this command.

The text home address indicates the leftmost and uppermost position.

The relationship between external display RAM address and display position

ТН	TH+CL
TH+TA	TH+TA+CL
(TH+TA)+TA	TH+2TA+CL
(TH+2TA)+TA	TH+3TA+CL
TH+(n-1)TA	TH+(n-1)TA+CL

TH: Text home address

TA: Text area number (columns)

CL: Columns are fixed by hardware (pin-programmable).

(Example)

Text home address : 0000H
Text area : 0020H

: 32 Columns

: 4 Lines

0000Н	0001H	001EH	001FH
0020Н	0021H	003EH	002FH
0040H	0041H	005EH	005FH
0060Н	0061H	007EH	007FH

(2)Set Graphic Home Address

The starting address of the external display RAM used for graphic display is defined by this command.

The graphic home address indicates the leftmost and uppermost position.

The relationship between external display RAM address and display position

GH	GH+GL
GH+GA	GH+GA+CL
(GH+GA)+GA	GH+2GA+CL
(GH+2GA)+GA	GH+3GA+CL
GH+(n-1)GA	GH+(n-1)GA+CL

GH: Graphic home address

GA: Graphic area number (columns)

CL: Columns are fixed by hardware (pin-programmable).

(Example)

Graphic home address : 0000H

Graphic area : 0020H

: 32 Columns

: 2 Lines

0000Н	0001H	001EH	001FH
0020H	0021Н	003EH	003FH
0040H	0041H	005EH	005FH
0060H	0061H	007EH	007FH
0080Н	0081H	009EH	009FH
00A0H	00A1H	00BEH	00BFH
00С0Н	00C1H	00DEH	00DFH
00E0H	00E1H	00FEH	00FFH
0100H	0101H	011EH	011FH
0120H	0121H	013EH	013FH
0140H	0141H	015EH	014FH
0160Н	0161H	017EH	017FH
0180H	0181H	109EH	019FH
01A0H	01A1H	01BEH	01BFH
01C0H	01C1H	01DEH	01DFH
01E0H	01E1H	01FEH	01FFH

(3)Set Text Area

The display columns are defined by the hardware Setting. This command can be used to adjust the columns of the display.

(Example)

LCD size 20 columns, 4lines

Text home address 0000H

Text area 0014H

Set 32 columns, 4 Lines

0000	0001	 0013	0014	 001F
0014	0015	 0027	0028	 0033
0028	0029	 003B	003C	 0047
003C	003D	 004F	0050	 005B

LCD



(4)Set Graphic Area

The display columns are defined by the hardware setting. This command can be used to adjust the columns of the graphic display.

(Example)

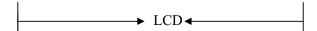
LCD size 20 columns, 2lines

Graphic home address : 0000H

Graphic are : 0014H

Set 32 columns, 2 Lines

0000	0001	 0013	0014	 001F
0014	0015	 0027	0028	 0033
0028	0029	 003B	003C	 0047
003C	003D	 004F	0050	 005B
0050	0051	 0063	0064	 006F
0064	0065	 0077	0078	 0083
0078	0079	 008B	008C	 0097
008C	008D	 009F	00A0	 00AB
00A0	00A1	 00B3	00B4	 00BF
00B4	00B5	 00C7	00C8	 00D3
00C8	00C9	 00DB	00DC	 00E7
00DC	00DD	 00EF	00F0	 00FD
00F0	00F1	 0103	0104	 011F
0104	0105	 0127	0128	 0123
0128	0129	 013B	0013C	 00147
013C	013D	 014F	0150	 015B



If the graphic area setting is set to match the desired number of columns on the LCD, the addressing scheme will be automatically modified so that the start address of each line equals the end address of the previous line +1.

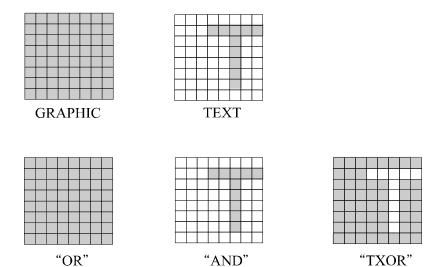
· Mode set

CODE	FUNCTION	OPERAND
1000x000	OR Mode	-
1000x001	EXOR Mode	-
1000x011	AND Mode	-
1000x100	TEXT ATTRIBUTE Mode	_
10000xxx	Internal Character Generator Mode	-
10001xxx	External Character Generator Mode	-

X: invalid

The display mode is defined by this command. The display mode does not change until the next command is sent. The logical OR, EXOR, AND of text or graphic display can be displayed. In Internal Character Generator mode, character codes 00H to 7FH are assigned to the built-in character generator ROM. The character codes 80H to FFH are automatically assigned to the external character generator RAM.

(Example)



(Note)Attribute functions can only be applied to text display, since the attribute data is placed in the graphic RAM area.

Attribute function

The attribute operations are Reverse display, Character blink and Inhibit. The attribute data is written into the graphic area which was defined by the Set Control Word command. Only text display is possible in Attribute Function mode; graphic display is automatically disabled. However, the Display Mode command must be used to turn both Text and Graphic on in order for the Attribute function to be available.

The attribute data for each character in the text area is written to the same address in the graphic area. The Attribute function is defined as follows.

Attribute RAM 1byte

٧.								
	×	×	×	×	d3	d2	d1	d0

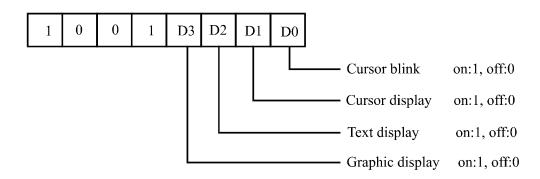
d3	d2	d1	d0	FUNCTION
0	0	0	0	Normal display
0	1	0	1	Reverse display
0	0	1	1	Inhibit display
1	0	0	0	Blink of normal display
1	1	0	1	Blink of reverse display
1	0	1	1	Blink of inhibit display

X: invalid

· Display mode

CODE	FUNCTION	OPERAND
10010000	Display off	-
1001xx10	Cursor on, blink off	-
1001xx11	Cursor on, blink on	-
100101xx	Text on, graphic off	-
100110xx	Text off, graphic on	-
100111xx	Text on, graphic on	-

X: invalid



Page 27 of 49

(Note)It is necessary to turn on "Text display" and "Graphic display" in the following cases.

- a)Combination of text/graphic display
- b)Attribute function

· Cursor pattern select

CODE	FUNCTION	OPERAND
10100000	1-line cursor	-
10100001	2-line cursor	-
10100010	3-line cursor	-
10100011	4-line cursor	-
10100100	5-line cursor	-
10100101	6-line cursor	-
10100110	7-line cursor	-
10100111	8-line cursor	-

When cursor display is ON, this command selects the cursor pattern in the range 1 line to 8 lines.

The cursor address is defined by the Cursor Pointer Set command.



1-line cursor



2-line cursor



8-line cursor

· Data Auto Read/Write

CODE	HEX.	FUNCTION	OPERAND
10110000	В0Н	Set Data Auto Write	-
10110001	B1H	Set Data Auto Read	-

10110010	В2Н	Auto Reset	-
----------	-----	------------	---

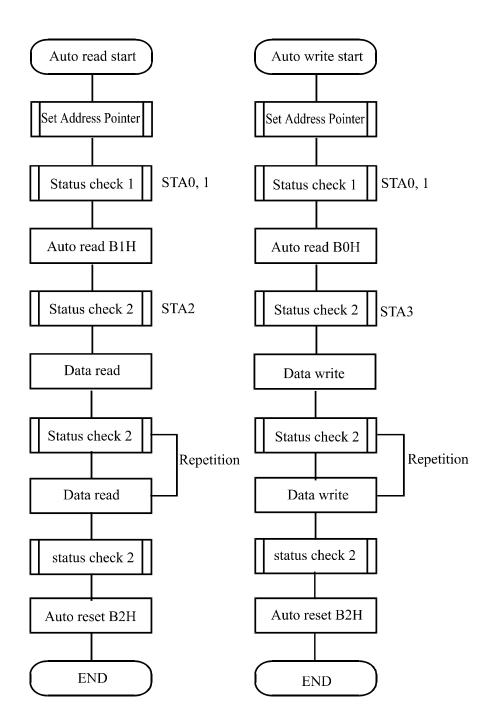
The command is convenient for sending a full screen of data from the external display RAM. After setting Auto mode, a Data Write (or Read) command is need not be sent between each datum. A Data Auto Write (or Read) command must be sent after a Set Address Pointer command. After this command, the address pointer is automatically incremented by 1 after each datum. In Auto mode, the T6963C cannot accept any other commands.

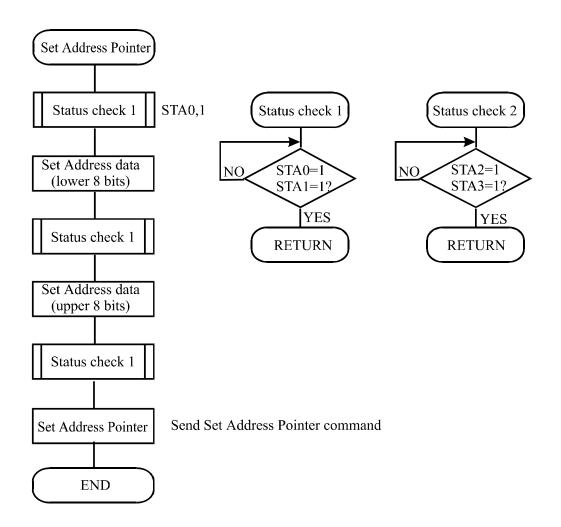
The Auto Reset command must be sent to the T69963C after all data has been sent, to clear Auto mode. (Note)A Status check for Auto mode

(STA2, STA3 should be checked between sending of each datum. Auto Reset should be performed after checking STA3=1 (STA2=1.) Refer to the following flowchart.

a)Auto Read mode

b)Auto Write mode



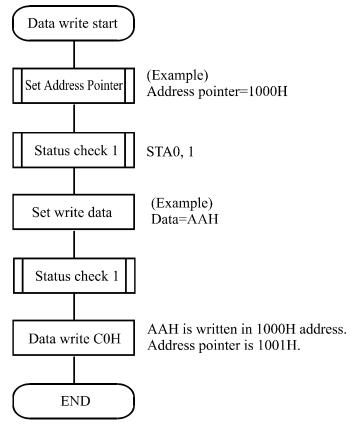


· Date Read/Write

CODE	HEX.	FUNCTION	OPERAND
11000000	СОН	Data Write and Increment ADP	Data
11000001	C1H	Data Read and Increment ADP	-
11000010	С2Н	Data Write and Decrement ADP	Data
11000011	СЗН	Data Read and Decrement ADP	-
11000100	С4Н	Data Write and Non-variable ADP	Data
11000101	С5Н	Data Read and Non-variable ADP	-

This command is used for writing data from the MPU to external display RAM, and reading data from external display RAM to the MPU. Data Write/Data Read should be executed after setting address using Set Address Pointer command. The address pointer can be automatically incremented or decremented using this command.

(Note)This command is necessary for each 1-byte datum.



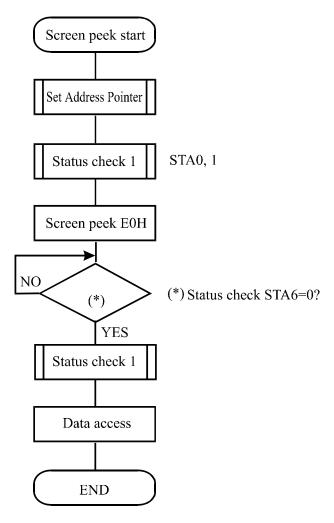
Page 32 of 49

· Screen Peek

CODE	HEX.	FUNCTION	OPERAND
11100000	Е0Н	Screen Peek	- e

This command is used to transfer 1 byte of displayed data to the data stack; this byte can then be read from the MPU by data access. The logical combination of text and graphic display data on the LCD screen can be read by this command.

The status (STA6) should be checked just after the Screen Peek command. If the address determined by the Set Address Pointer command is not in the graphic area, this commands is ignored and a status flag (STA6) is set.



· Screen Copy

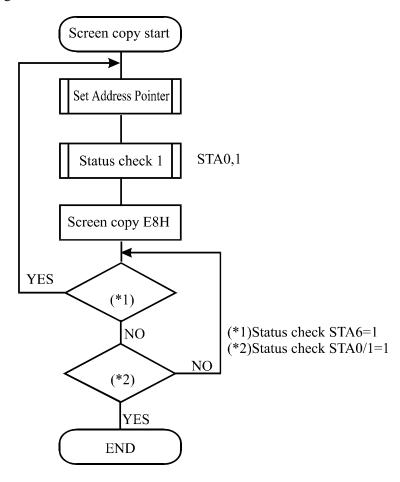
CODE	HEX.	FUNCTION	OPERAND
11101000	E8H	Screen Copy	-

This command copies a single raster line of data to the graphic area.

The start point must be set using the Set Address Pointer command.

(Note 1) If the attribute function is being used, this command is not available.

(With Attribute data is graphic area data.)



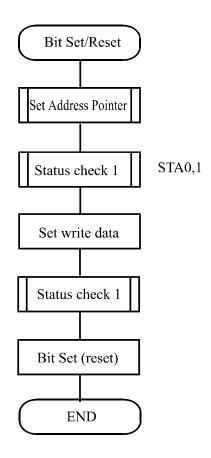
· Bit Set/Reset

CODE	FUNCTION	OPERAND
11110xxx	Bit Reset	-
11111xxx	Bit Set	-
1111x000	Bit 0 (LSB)	-
1111x001	Bit 1	-
1111x010	Bit 2	-
1111x011	Bit 3	-
1111x100	Bit 4	-
1111x101	Bit 5	-
1111x110	Bit 6	-
1111x111	Bit 7 (MSB)	-

X: invalid

This command use to set or reset a bit of the byte specified by the address pointer.

Only one bit can be set/reset at a time.



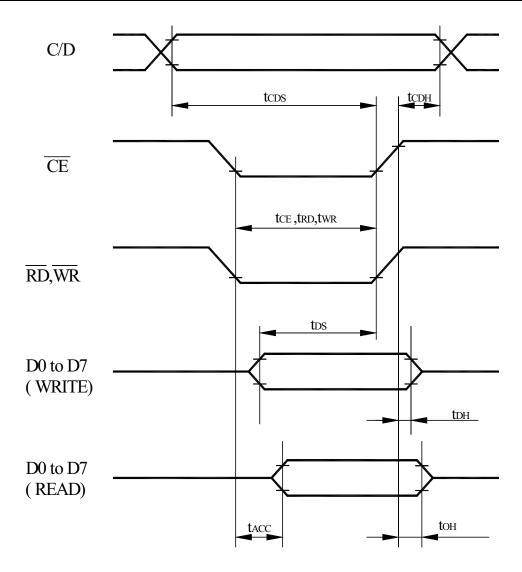
CHARACTER CODE MAP

Company Comp	Llopon			I			1		
LLLH		LLLL	LLLH						LHHH
LL НН 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1						=:	!	::::	
ССНИН 1.00	LLLH	1	i.			-::::	-:::[!!	
СНИСТ 10000 10000 10000 10000	LLHL	11				ļ;	[-""		
СНИСН 1.1.1 <t< td=""><td>LLHH</td><td></td><td>-,,,;</td><td> </td><td> </td><td></td><td> </td><td></td><td>:::::</td></t<>	LLHH		-,,,;						:::::
LHHL 1.1.1 <td< td=""><td>LHLL</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>:::::</td></td<>	LHLL								:::::
НЕННИ 1000	LHLH								
НЕСТ 1.1 <td< td=""><td>LHHL</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></td<>	LHHL								
нын	LHHH	:=	*****			-::::	1,:,1	•::::	 !!
ныны	HLLL	ŧ.,			::::	ļ.";]:-: <u>`</u>		••
нын	HLLH				**	i.	•::::	•	
HHLL 28 24 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	HLHL	•••••	11	·!		i			ii
ннын	н∟нн]	::	! -::.		! -::	***	11.	
нннц е 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 -	HHLL	;=	••••		****	ì.		 3.	
	HHLH					l'i'i		*.	
нннн	HHHL	**			"	i-"i	***.*		
	НННН	"	*****			ii			

11. Timing Characteristics

Bus Timing (Vss = 0 V, VDD = 5 V)

Item	Symbol	Min	Тур	Max	Unit
C/D Set-up Time	tcds	100	-	-	ns
C/D Hold Time	tcdн	10	-	-	ns
CE,RD,WR Pulse Width	tcds,trd,twr	80	-	-	ns
Data Set-up Time	tDS	80	-	-	ns
Data Hold Time	tDH	40	-	-	ns
Access Time	tacc	-	-	150	ns
Output Hold Time	tон	10	-	50	ns



12. RELIABILITY

Content of Reliability Test (wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C ,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation $-20^{\circ}\mathbb{C} \qquad 25^{\circ}\mathbb{C} \qquad 70^{\circ}\mathbb{C}$ $30 \text{min} \qquad 5 \text{min} \qquad 30 \text{min}$ 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

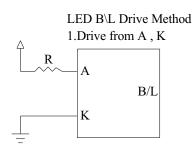
Note3: Vibration test will be conducted to the product itself without putting it in a container.

13. Backlight Information

Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	115.2	128	200	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	_
Reverse Voltage	VR	_	_	5	V	_
Luminous Intensity	IV	150		_	CD/M ²	ILED=128
Chromaticity Coordinate	X	_	0.300	_	nm	_
Chromaticity Coordinate	Y	_	0.310	_	nm	_
Life Time	_	_	50000	_	Hr.	ILED≦128
Color	White	1		<u> </u>		1

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).



14. Inspection specification

NO	Item			(Criterion		AQL
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 					
02	Black or white spots on LCD (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 				2.5	
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type: As follow $\Phi = (x + y)/2$ $X \qquad \qquad$		/ing	g drawing SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	2	2.5
03		contamination 3.2 Line type : (A		As followi Length L≤3.0 L≤2.5	ength Width Accept $W \le 0.02$ Accept ≤ 3.0 $0.02 < W \le 0.03$ ≤ 2.5 $0.03 < W \le 0.05$		Acceptable Q TY Accept no dense 2 As round type
04	Polarizer bubbles	If bubbles are vis judge using black specifications, no to find, must che specify direction	k spot ot easy eck in	0.	Size Φ $\Phi \leq 0.20$ $20 < \Phi \leq 0.50$ $50 < \Phi \leq 1.00$ $00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

NO	Item	Criterion									
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination									
			t: Glass thickness th:	z: Chip thickness a: LCD side length							
		6.1.1 Chip on panel surface and crack between panels:									
		z: Chip thickness	y: Chip width	x: Chip length							
	Chinned	Z≦1/2t	Not over viewing area	x ≤ 1/8a							
06	Chipped glass	1/2t < z≦2t	Not exceed 1/3k	x≤1/8a	2.5						
		⊙ If there are 2 or mor 6.1.2 Corner crack:	X Z	= y							
		z: Chip thickness	y: Chip width	x: Chip length							
		Z≦1/2t	Not over viewing area	x ≦ 1/8a							
		1/2t < z≤2t	Not exceed 1/3k	x≤1/8a							
	⊙ If there are 2 or more chips, x is the total length of each chip.										

NO	Item	Criterion	AQL							
		Symbols:								
		x: Chip length y: Chip width z: Chip thickness								
		k: Seal width t: Glass thickness a: LCD side length								
		L: Electrode pad length								
		6.2 Protrusion over terminal:								
		6.2.1 Chip on electrode pad :								
		· · · · · · · · · · · · · · · · · · ·								
		2								
		N N N								
		y: Chip width x: Chip length z: Chip thickness								
		$y \le 0.5 \text{mm} \qquad x \le 1/8 \text{a} \qquad 0 < z \le t$								
		6.2.2 Non-conductive portion:								
		بأسيا								
0.6	Glass		2.5							
06	crack	12	2.5							
		y Z								
		X								
		y: Chip width x: Chip length z: Chip thickness								
		$y \le L \qquad x \le 1/8a \qquad 0 < z \le t$								
		υ · Z ≟ t								
		⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO								
		must remain and be inspected according to electrode terminal								
		specifications.								
		⊙ If the product will be heat sealed by the customer, the alignment								
		mark not be damaged.								
		6.2.3 Substrate protuberance and internal crack.								
		y: width x: length								
		$y \le 1/3L \qquad x \le a$								
		у								

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or contamination.10.2 COB seal surface may not have pinholes through to the	2.5 2.5 0.65
10	PCB, COB	 IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Ports on PCB must be the source or on the production. 	2.5 2.5 0.65
		10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.10.7 The jumper on the PCB should conform to the	0.65
		product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB X * Y <= 2mm ²	2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections,	2.5 2.5

	oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 0.65
--	---	-------------

NO	Item	Criterion	AQL
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65

15. Material List of Components for RoHs

1. Newhaven Display International hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

.

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs	
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	
Above limited value is set up according to RoHS.							

- 2. Process for RoHS requirement:
- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250° C, 30 seconds Max.;

Connector soldering wave or hand soldering: 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : $235\pm5^{\circ}$ C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

Newhaven <u>LCM Sample Estimate Feedback Sheet</u>

Module Number:				Page: 1
1. Panel Specification:				
1. Panel Type:	Pass		NG,_	
2. View Direction:	Pass			
3. Numbers of Dots:	Pass			
4. View Area:	Pass			
5. Active Area:	Pass		NG,_	
6. Operating Temperature:	Pass		NG,_	
7. Storage Temperature:	Pass		NG,_	
8. Others:				
2. Mechanical				
1. PCB Size :	Pass		NG,_	
2. Frame Size:	Pass		NG ,_	
3. Materal of Frame:	Pass		NG ,_	
4. Connector Position:	Pass		NG ,_	
5. Fix Hole Position:	Pass		NG ,_	
6. Backlight Position:	Pass		NG,_	
7. Thickness of PCB:	Pass		NG,_	
8. Height of Frame to	Pass		NG,_	
⁹ · Height of Module:	Pass		NG,_	
Others:	Pass		NG,_	
3, Relative Hole Size:				
1. Pitch of Connector:	Pass		NG ,_	
2. Hole size of Connector:	Pass		NG ,_	
3. Mounting Hole size:	Pass		NG ,_	
⁴ . Mounting Hole Type:	Pass		NG ,_	
5. Others:	Pass		NG ,_	
4、 Backlight Specification:				
B/L Type:	Pass		NG ,	
B/L Color:	Pass		NG,	
3		D	□ Pas	ss \square NG,
B/L Driving Current:	Pass		NG,	

_	Brightness of B/L:		Pass		NG ,		_
5	B/L Solder Method:		Pass	□ <u>}</u>	NG ,		_
6	Others:		Pass				
7		>	> Go to				
	Newhaven						
Module N	Tumber :					Page: 2	
5、 <u>Ele</u>	ectronic Characteristics o	f M	odule :				
1. Inp	put Voltage:		Pass		NG ,		
2. Su	pply Current:		Pass				
3. Dr	riving Voltage for LCD:		Pass				
4. Co	ontrast for LCD:		Pass		NG ,		
5. B/	L Driving Method:		Pass				
6. Ne	egative Voltage Output:		Pass		NG ,		
7. Int	terface Function:		Pass		NG ,		
8. LC	CD Uniformity:		Pass		NG ,		
9. ES	SD test:		Pass		NG ,		
10. Ot	hers:		Pass				
6, <u>Su</u>	mmary :						

Sales signature:	<u>-</u>			
Customer Signature :	Date:	/	/	